

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

RELEASE BY SECURED PARTY

CONVEYING PARTY DATA

Name	Execution Date
VENTURE LENDING & LEASING IV, INC.	03/26/2007

RECEIVING PARTY DATA

Name:	MOLECULAR IMPRINTS, INC.
Street Address:	1807-C W Braker Ln, Suite 100
City:	Austin
State/Country:	TEXAS
Postal Code:	78758

PROPERTY NUMBERS Total: 67

Property Type	Number
Application Number:	10194414
Application Number:	10194411
Application Number:	10194410
Application Number:	10210894
Application Number:	10210785
Application Number:	10210780
Application Number:	10227105
Application Number:	10235314
Application Number:	10264960
Application Number:	10264926
Application Number:	10293919
Application Number:	10293224
Application Number:	10293223
Application Number:	10316963
Application Number:	10318365

PATENT

500247424

REEL: 019072 FRAME: 0882

CH \$2680.00 10194414

Application Number:	10375832
Application Number:	10375817
Application Number:	10396615
Application Number:	10423642
Application Number:	10438224
Application Number:	10437476
Application Number:	10445863
Application Number:	10614716
Application Number:	10616294
Application Number:	10645306
Application Number:	10670980
Application Number:	10706537
Application Number:	10714088
Application Number:	10735110
Application Number:	10758384
Application Number:	10757778
Application Number:	10760821
Application Number:	10763885
Application Number:	10782187
Application Number:	10789319
Application Number:	10788700
Application Number:	10827119
Application Number:	10827118
Application Number:	10833240
Application Number:	10843194
Application Number:	10850876
Application Number:	10858566
Application Number:	10858179
Application Number:	10858100
Application Number:	10863800
Application Number:	10864591
Application Number:	10868683
Application Number:	10895214
Application Number:	10897734
Application Number:	10917761

Application Number:	10917563
Application Number:	10919224
Application Number:	10919062
Application Number:	10923629
Application Number:	10923628
Application Number:	10178947
Application Number:	10463396
Application Number:	10667639
Application Number:	10687562
Application Number:	10687519
Application Number:	10694284
Application Number:	10784911
Application Number:	10898037
Application Number:	10898034
Application Number:	10136188
Application Number:	10191749
Application Number:	10194991

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	29739.025
NAME OF SUBMITTER:	Nancy Bouch

Total Attachments: 13

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Recordation Form Cover Sheet
For Patents
Molecular Imprints, Inc.

Application Numbers

10/194,414

10/194,411

10/194,410

10/210,894

10/210,785

10/210,780

10/227,105

10/235,314

10/264,960

10/264,926

10/293,919

10/293,224

10/293,223

10/316,963

10/318,365

10/375,832

10/375,817

10/396,615

10/423,642

10/438,224

10/437,476

10/445,863

10/614,716

10/616,294

10/645,306

10/670,980

10/706,537

10/714,088

10/735,110

Recordation Form Cover Sheet
For Patents
Molecular Imprints, Inc.

Application Numbers

10/758,384

10/757,778

10/760,821

10/763,885

10/782,187

10/789,319

10/788,700

10/827,119

10/827,118

10/833,240

10/843,194

10/850,876

10/858,566

10/858,179

10/858,100

10/863,800

10/864,591

10/868,683

10/895,214

10/897,734

10/917,761

10/917,563

10/919,224

10/919,062

10/923,629

10/923,628

10/178,947

10/463,396

10/677,639

Recordation Form Cover Sheet
For Patents
Molecular Imprints, Inc.

Application Numbers

10/687,562

10/687,519

10/694,284

10/784,911

10/898,037

10/898,034

10/136,188

10/191,749

10/194,991

TERMINATION AND RELEASE OF INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Termination and Release of Intellectual Property Security Agreement (the "Agreement"), is made as of March 26, 2007, by VENTURE LENDING & LEASING IV, INC., a Maryland corporation ("Secured Party"), in favor of MOLECULAR IMPRINTS, INC., a Delaware corporation (together with its successors and assigns, the "Grantor").

R E C I T A L S

A. Reference is made to a Loan and Security Agreement, dated as of September 28, 2004 (together with the Supplement to the Loan and Security Agreement, the "Loan Agreement"), by and between Grantor and Secured Party, whereby Grantor granted to Secured Party a security interest in Grantor's entire right, title and interest in all Intellectual Property of the Grantor (the "Collateral").

B. A Grant of Security Interest in Intellectual Property was filed with the United States Patent and Trademark Office, Patent Division, on January 11, 2005, at Reel/Frame 003103/0787 to evidence the security interest in patents and patent applications granted under the Loan Agreement.

C. A Grant of Security Interest in Intellectual Property was filed with the United States Patent and Trademark Office, Trademark Division, on January 11, 2005, at Reel/Frame 016133/0369 to evidence the security interest in trademarks and trademark applications granted under the Loan Agreement.

D. Debtor has provided cash collateral for its Obligations under the Loan Agreement and as a result, Grantor has requested, and Secured Party has agreed, to release its security interest in the Collateral.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Secured Party agrees as follows:

1. Secured Party hereby expressly confirms the termination and release to Grantor of its security interest in and to all Collateral, including, but not limited to:

(a) All letters patent of, or rights corresponding thereto in, the United States or any other country, all registrations and recordings thereof, and all applications for letters patent of, or rights corresponding thereto in the United States or any other country, including, without limitation, registrations, recordings and applications in the United States Patent and Trademark Office or in any similar office or agency of the United States, any State thereof or any other country; all reissues, continuations, continuations-in-part or extensions thereof; all petty patents, divisionals, and patents of addition; and all patents to be issued under any such applications, including without limitation each patent and patent application set forth on Exhibit A attached hereto (collectively, the "Patents");

(b) All trademarks, trade names, corporate names, business names, trade styles, service marks, logos, other source or business identifiers, prints and labels on which any of the foregoing have appeared or appear, designs and general intangibles of like nature, all registrations and recordings thereof, and any applications in connection therewith, including, without limitation, registrations, recordings and applications in the United States Patent and Trademark Office or in any similar office or agency of the United States, any State thereof or any other country or political subdivision thereof, and reissues, extensions or renewals thereof and the entire goodwill of the business of Grantor connected with and symbolized by such trademarks, including without limitation each trademark and trademark application set forth on Exhibit B attached hereto (collectively, the "Trademarks").

2. Secured Party authorizes and requests that the Commissioner for Patents and Trademarks and any other government officer record this Release.

IN WITNESS WHEREOF, Secured Party has executed and delivered this Termination and Release as of the day and year first above written.

VENTURE LENDING & LEASING IV, INC.

By: 

Name: Jay L. Cohan

Title: Vice President

EXHIBIT A
PATENTS AND PATENT APPLICATIONS

EXHIBIT A

MOLECULAR IMPRINTS, INC. IS THE SOLE OWNER OF THE RIGHTS IN THE FOLLOWING U.S. PATENT DOCUMENTS

Title	Filing Date	App. No.
1) Methods Of Manufacturing A Lithography Template	5/1/2002	10/136,188
2) Method For Dispensing Liquids (As Amended)	7/9/2002	10/191,749
3) Step And Repeat Imprint Lithography Process	7/11/2002	10/194,991
4) Step And Repeat Imprint Lithography Systems	7/11/2002	10/194,414
5) Formation Of Discontinuous Films During An Imprint Lithography Process	7/11/2002	10/194,411
6) Method And System For Imprint Lithography Using An Electric Field	7/11/2002	10/194,410
7) Alignment Systems For Imprint Lithography	8/1/2002	10/210,894
8) Scatterometry Alignment For Imprint Lithography	8/1/2002	10/210,785
9) Alignment Methods For Imprint Lithography	8/1/2002	10/210,780
10) Method For Fabricating Bulbous-Shaped Vias	8/23/2002	10/227,105
11) Functional Patterning Material For Imprint Lithography Processes	9/5/2002	10/235,314
12) A Method And A Mold To Arrange Features On A Substrate To Replicate Features Having Minimal Dimensional Variability	10/4/2002	10/264,960
13) A Method Of Forming A Layer On A Substrate To Facilitate Fabrication Of Metrology Standards	10/4/2002	10/264,926
14) Methods Of Inspecting A Lithography Template	11/13/2002	10/293,919
15) A Chucking System For Modulating Shapes Of Substrates	11/13/2002	10/293,224
16) Method Of Reducing Pattern Distortions During Imprint Lithography Processes	11/13/2002	10/293,223
17) A Method For Modulating Shapes Of Substrates	12/11/2002	10/316,963
18) Method And System For Determining Characteristics Of Substrates Employing Fluid Geometries	12/12/2002	10/318,365
19) Composition And Method To Form A Release Layer	2/27/2003	10/375,832
20) Method To Reduce Adhesion Between A Polymerizable Layer And A Substrate Employing A Fluorine-Containing Layer	2/27/2003	10/375,817
21) Positive Tone Bi-Layer Imprint Lithography Method	3/25/2003	10/396,615
22) A Method Of Forming Stepped Structures Employing Imprint Lithography	4/25/2003	10/423,642

Title	Filing Date	App. No.
23) Method, System And Holder For Transferring Templates During Imprint Lithography Processes	5/14/2003	10/438,224
24) Assembly And Method For Transferring Imprint Lithography Templates	5/14/2003	10/437,476
25) High-Resolution Overlay Alignment Systems For Imprint Lithography	5/27/2003	10/445,863
26) A Conforming Template For Patterning Liquids Disposed On Substrates	7/7/2003	10/614,716
27) Systems For Magnification And Distortion Correction For Imprint Lithography Processes	7/9/2003	10/616,294
28) Capillary Imprinting Technique	8/21/2003	10/645,306
29) Imprint Lithography Template Having Opaque Alignment Marks	9/25/2003	10/670,980
30) Formation Of Conductive Templates Employing Indium Tin Oxide	11/12/2003	10/706,537
31) Dispense Geometry To Achieve High-Speed Filling And Throughput	11/14/2003	10/714,088
32) Magnification Correction Employing Out-Of-Plane Distortion Of A Substrate	12/12/2003	10/735,110
33) Thermal Processing System For Imprint Lithography	1/15/2004	10/758,384
34) A Method To Improve The Flow Rate Of Imprinting Material	1/15/2004	10/757,778
35) Method For Concurrently Employing Differing Materials To Form A Layer On A Substrate	1/20/2004	10/760,821
36) Materials And Methods For Imprint Lithography	1/23/2004	10/763,885
37) Method And System To Measure Characteristics Of A Film Disposed On A Substrate	2/19/2004	10/782,187
38) Composition For An Etching Mask Comprising A Silicon-Containing Material	2/27/2004	10/789,319
39) Full-Wafer Or Large Area Imprinting With Multiple Separated Sub-Fields For High Throughput Lithography	2/27/2004	10/788,700
40) A Method Of Inspecting Substrates Employing Signal Superimposition	4/19/2004	10/827,119
41) Method Of Forming A Deep-Featured Template Employed In Imprint Lithography	4/19/2004	10/827,118
42) Compliant Hard Template For UV Imprinting	4/27/2004	10/833,240
43) Method Of Patterning A Conductive Layer On A Substrate	5/11/2004	10/843,194
44) A Method Of Forming A Recessed Structure Employing A Reverse Tone Process	5/21/2004	10/850,876

Title	Filing Date	App. No.
45) A Method Of Dispensing A Fluid On A Substrate	6/1/2004	10/858,566
46) A Compliant Device For Nano-Scale Manufacturing	6/1/2004	10/858,179
47) Method And System To Control Movement Of A Body For Nano-Scale Manufacturing	6/1/2004	10/858,100
48) System For Determining Characteristics Of Substrates Employing Fluid Geometries	6/8/2004	10/863,800
49) A Chucking System For Modulating Shapes Of Substrates	6/9/2004	10/864,591
50) System For Dispensing Liquids	6/15/2004	10/868,683
51) Imprint Alignment Method, System And Template	7/20/2004	10/895,214
52) Imprinting Of Displays	7/23/2004	10/897,734
53) Moat System For An Imprint Lithography Template	8/13/2004	10/917,761
54) A Method Of Planarizing A Semiconductor Substrate	8/13/2004	10/917,563
55) Method To Provide A Layer With Uniform Etch Characteristics	8/16/2004	10/919,224
56) Composition To Provide A Layer With Uniform Etch Characteristics	8/16/2004	10/919,062
57) Apparatus For Imprint Lithography Using An Electric Field	8/20/2004	10/923,629
58) System For Determining Characteristics Of Substrates Employing Fluid Geometries	8/20/2004	10/923,628

MOLECULAR IMPRINTS SHARES THE OWNERSHIP OF THE RIGHTS IN THE FOLLOWING U.S. PATENT DOCUMENTS WITH ONE OTHER ORGANIZATION

1) Low Viscosity High Resolution Patterning Material	6/24/2002	10/178,947
2) Method To Reduce Adhesion Between A Conformable Region And A Pattern Of A Mold	6/17/2003	10/463,396
3) Single Phase Fluid Imprint Lithography Method	10/2/2003	10/677,639
4) Applying Imprinting Material To Substrates Employing Electromagnetic Fields	10/16/2003	10/687,562
5) Low Surface Energy Templates	10/16/2003	10/687,519
6) Methods For Fabricating Patterned Features Utilizing Imprint Lithography	10/27/2003	10/694,284
7) Materials For Imprint Lithography	2/23/2004	10/784,911
8) An Apparatus For Creating A Turbulent Flow Of Fluid Between A Mold And A Substrate	7/23/2004	10/898,037
9) Method For Creating A Turbulent Flow Of Fluid Between A Mold And A Substrate	7/23/2004	10/898,034

**MOLECULAR IMPRINTS, INC. IS THE SOLE OWNER OF THE RIGHTS IN THE
FOLLOWING INTERNATIONAL AND FOREIGN PATENT DOCUMENTS**

1)	A Chucking System and Method for Modulating Shapes of Substrates	PCT	Nov 12, 2003	PCT/US03/36012
2)	A Chucking System and Method for Modulating Shapes of Substrates	MY	Nov 12, 2003	PI 20034332
3)	A Chucking System and Method for Modulating Shapes of Substrates	TW	Nov 12, 2003	92131719
4)	A Chucking System and Method for Modulating Shapes of Substrates	DE	May 17, 2004	203 20 446.8
5)	A Method and a Mold to Arrange Features on a Substrate to Replicate Features Having Minimal Dimensional Variability	PCT	Sep 18, 2003	PCT/US03/29061
6)	A Method and a Mold to Arrange Features on a Substrate to Replicate Features Having Minimal Dimensional Variability	MY	Sep 25, 2003	PI 20033654
7)	A Method and a Mold to Arrange Features on a Substrate to Replicate Features Having Minimal Dimensional Variability	TW	Sep 26, 2003	92126696
8)	A Method of Forming Stepped Structures Employing Imprint Lithography	PCT	Apr 21, 2004	PCT/US04/12313
9)	A Method of Forming Stepped Structures Employing Imprint Lithography	MY	Apr 23, 2004	PI 20041496
10)	A Method of Forming Stepped Structures Employing Imprint Lithography	TW	Apr 23, 2004	93111426
11)	Capillary Imprinting Technique	PCT	Aug 13, 2004	PCT/US04/26337
12)	Capillary Imprinting Technique	PCT	Aug 13, 2004	PCT/US04/26337
13)	Capillary Imprinting Technique	MY	Aug 17, 2004	
14)	Capillary Imprinting Technique	TW	Aug 20, 2004	93125173
15)	Formation of Discontinuous Films During an Imprint Lithography Process	PCT	Jul 10, 2003	PCT/US03/21556
16)	Formation of Discontinuous Films During an Imprint Lithography Process	MY	Jul 7, 2003	PI 20032546
17)	Formation of Discontinuous Films During an Imprint Lithography Process	TW	Jul 10, 2003	92118881
18)	Magnification Correction Employing Out-Of-Plane Distortion of a Substrate	PCT	Dec 12, 2003	PCT/US03/39448
19)	Magnification Correction Employing Out-Of-Plane Distortion of a Substrate	MY	Dec 12, 2003	PI 20034775
20)	Magnification Correction Employing Out-Of-Plane Distortion of a Substrate	TW	Dec 12, 2003	92135221
21)	Method And System For Determining Characteristics Of Substrates Employing Fluid Geometries	PCT	Dec 12, 2003	PCT/US03/39449
22)	Method and System for Imprint Lithography Using an Electric Field	MY	Jul 7, 2003	PI 20032545
23)	Method and System for Imprint Lithography Using an Electric Field	TW	Jul 10, 2003	92118873

24) Method, System, Holder and Assembly for Transferring Templates during Imprint Lithography Processes	PCT	May 11, 2004	PCT/US04/14720
25) Positive Tone Bi-Layer Imprint Lithography Method and Compositions Therefor	PCT	Mar 24, 2004	PCT/US04/08920
26) Positive Tone Bi-Layer Imprint Lithography Method and Compositions Therefor	MY	Mar 25, 2004	PI 20041060
27) Positive Tone Bi-Layer Imprint Lithography Method and Compositions Therefor	TW	Mar 24, 2004	93107963
28) Scatterometry Alignment for Imprint Lithography	PCT	Jul 31, 2003	PCT/US03/23948
29) Scatterometry Alignment for Imprint Lithography	MY	Jul 30, 2003	PI 20032888
30) Scatterometry Alignment for Imprint Lithography	TW	Jul 31, 2003	92120993
31) Step and Repeat Imprint Lithography Process	MY	Jul 7, 2003	PI 20032541
32) Step and Repeat Imprint Lithography Process	TW	Jul 10, 2003	92118862
33) Step and Repeat Imprint Lithography Systems	MY	Jul 7, 2003	PI-20032540
34) Step and Repeat Imprint Lithography Systems	TW	Jul 10, 2003	92118883
35) System and Method for Dispensing Liquids	PCT	Jun 19, 2003	PCT/US03/19258
36) System and Method for Dispensing Liquids	MY	Jun 27, 2003	PI-20032433
37) System and Method for Dispensing Liquids	TW	Jun 30, 2003	92117835
38) Systems for Magnification and Distortion Correction for Imprint Lithography Processes	PCT	Jul 9, 2004	PCT/US04/22454
39) Systems for Magnification and Distortion Correction for Imprint Lithography Processes	MY	Jul 9, 2004	PI 20042743
40) Systems for Magnification and Distortion Correction for Imprint Lithography Processes	TW	Jul 8, 2004	93120450

**MOLECULAR IMPRINTS SHARES THE OWNERSHIP OF THE RIGHTS IN THE
FOLLOWING INTERNATIONAL AND FOREIGN DOCUMENTS WITH ONE OTHER
ORGANIZATION**

1) Method to Reduce Adhesion Between a Conformable Region and a Pattern of a Mold	PCT	6/10/2004	PCT/US2004/01885 7
2) Method to Reduce Adhesion Between a Conformable Region and a Pattern of a Mold	MY	6/15/2004	PI 20042293
3) Method to Reduce Adhesion Between a Conformable Region and a Pattern of a Mold	TW	6/16/2004	93117326

EXHIBIT B
TRADEMARK AND TRADEMARK APPLICATIONS

THIS EXHIBIT INTENTIONALLY OMITTED